

Final datasheet**Highly insulated module with TRENCHSTOP™ IGBT7 and emitter controlled 7 diode****Features**

- Electrical features
 - $V_{CES} = 6500 \text{ V}$
 - $I_{C \text{ nom}} = 1500 \text{ A} / I_{CRM} = 3000 \text{ A}$
 - Low $V_{CE, \text{sat}}$
- Mechanical features
 - Extended storage temperature down to $T_{\text{stg}} = -55 \text{ }^{\circ}\text{C}$
 - Package with enhanced insulation of 10.4 kV AC 60 s
 - High creepage and clearance distances
 - Package with CTI > 600
 - AlSiC base plate for increased thermal cycling capability

**Potential applications**

- Medium-voltage converters
- Traction
- Power transmission and distribution

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

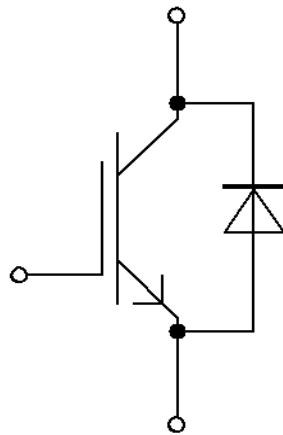
Description

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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 60 \text{ s}$	10.4	kV
Partial discharge extinction voltage	V_{isol}	RMS, $f = 50 \text{ Hz}$, $Q_{PD} \text{ typ } 10 \text{ pC}$	5.1	kV
DC stability	$V_{CE(D)}$	$T_{vj} = 25 \text{ °C}$, 100 Fit	3800	V
Material of module baseplate			AlSiC	
Internal isolation		basic insulation (class 1, IEC 61140)	AlN	
Comparative tracking index	CTI		> 600	

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{sCE}			18		nH
Module lead resistance, terminals - chip	$R_{AA'+CC'}$	$T_C = 25 \text{ °C}$, per switch		0.075		mΩ
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25 \text{ °C}$, per switch		0.095		mΩ
Storage temperature	T_{stg}		-55		125	°C
Mounting torque for module mounting	M	- Mounting according to valid application note	M6, Screw	4.25	5.75	Nm
Terminal connection torque	M	- Mounting according to valid application note	M4, Screw	1.8	2.1	Nm
			M8, Screw	8	10	
Weight	G			1400		g

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		$T_{vj} = -50 \text{ °C}$	5900	V
			$T_{vj} = 25 \text{ °C}$	6500	
			$T_{vj} = 135 \text{ °C}$	6500	
Continuous DC collector current	I_{CDC}	$T_{vj \text{ max}} = 135 \text{ °C}$	$T_C = 95 \text{ °C}$	1200	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj \text{ op}}$		3000	A
Gate-emitter peak voltage	V_{GES}			±20	V

Table 4 **Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 1500\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		2.28	2.58	V
			$T_{vj} = 125\ ^\circ C$		2.83		
			$T_{vj} = 135\ ^\circ C$		2.87	3.32	
Gate threshold voltage	V_{GETh}	$I_C = 108\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$		5.30	6.00	6.70	V
Gate charge	Q_G	$V_{GE} = \pm 15\ V, V_{CC} = 3600\ V, T_{vj} = 25\ ^\circ C$			11.4		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\ ^\circ C$			1.9		Ω
Input capacitance	C_{ies}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			177		nF
Reverse transfer capacitance	C_{res}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			0.17		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 6500\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			5	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$				400	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 1500\ A, V_{CC} = 3600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 4.3\ \Omega$	$T_{vj} = 25\ ^\circ C$		1.19		μs
			$T_{vj} = 125\ ^\circ C$		1.09		
			$T_{vj} = 135\ ^\circ C$		1.09		
Rise time (inductive load)	t_r	$I_C = 1500\ A, V_{CC} = 3600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 4.3\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.33		μs
			$T_{vj} = 125\ ^\circ C$		0.36		
			$T_{vj} = 135\ ^\circ C$		0.37		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 1500\ A, V_{CC} = 3600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 82\ \Omega$	$T_{vj} = 25\ ^\circ C$		15.2		μs
			$T_{vj} = 125\ ^\circ C$		15.9		
			$T_{vj} = 135\ ^\circ C$		16		
Fall time (inductive load)	t_f	$I_C = 1500\ A, V_{CC} = 3600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 82\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.43		μs
			$T_{vj} = 125\ ^\circ C$		1.47		
			$T_{vj} = 135\ ^\circ C$		1.64		
Turn-on time (resistive load)	t_{on_R}	$I_C = 500\ A, V_{CC} = 2000\ V, V_{GE} = \pm 15\ V, R_{Gon} = 4.3\ \Omega$	$T_{vj} = 25\ ^\circ C$	2.35			μs
Turn-on energy loss per pulse	E_{on}	$I_C = 1500\ A, V_{CC} = 3600\ V, L_\sigma = 150\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 4.3\ \Omega, di/dt = 3200\ A/\mu s (T_{vj} = 135\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		10430		mJ
			$T_{vj} = 125\ ^\circ C$		13220		
			$T_{vj} = 135\ ^\circ C$		13620		
Turn-off energy loss per pulse	E_{off}	$I_C = 1500\ A, V_{CC} = 3600\ V, L_\sigma = 150\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 82\ \Omega, dv/dt = 1110\ V/\mu s (T_{vj} = 135\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		8725		mJ
			$T_{vj} = 125\ ^\circ C$		10695		
			$T_{vj} = 135\ ^\circ C$		10990		

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
SC data	I_{SC}	$V_{GE} \leq 15 \text{ V}$, $V_{CC} = 4500 \text{ V}$, $V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$ $t_p \leq 6 \mu s$, $T_{vj} = 135 \text{ }^\circ\text{C}$		8350		A
Thermal resistance, junction to case	R_{thJC}	per IGBT			7.7	K/kW
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, $\lambda_{grease} = 1 \text{ W/(m}\cdot\text{K)}$		3.6		K/kW
Temperature under switching conditions	$T_{vj op}$		-50		135	$^\circ\text{C}$
Temperature under overload switching conditions	$T_{vj over}$	Overload, cumulative max. 4000s			150	$^\circ\text{C}$

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = -50 \text{ }^\circ\text{C}$	5900	V
		$T_{vj} = 25 \text{ }^\circ\text{C}$	6500	
		$T_{vj} = 135 \text{ }^\circ\text{C}$	6500	
Continuous DC forward current	I_F		1200	A
Repetitive peak forward current	I_{FRM}	$t_p = 1 \text{ ms}$	3000	A
I^2t - value	I^2t	$t_p = 10 \text{ ms}$, $V_R = 0 \text{ V}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	kA ² s
			$T_{vj} = 135 \text{ }^\circ\text{C}$	
Maximum power dissipation	P_{RQM}	$T_{vj} = 135 \text{ }^\circ\text{C}$	4500	kW
Minimum turn-on time	t_{onmin}		10	μs

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 1500 \text{ A}$, $V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		2.62	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$		2.60	
			$T_{vj} = 135 \text{ }^\circ\text{C}$		2.60	

(table continues...)

Table 6 (continued) Characteristic values

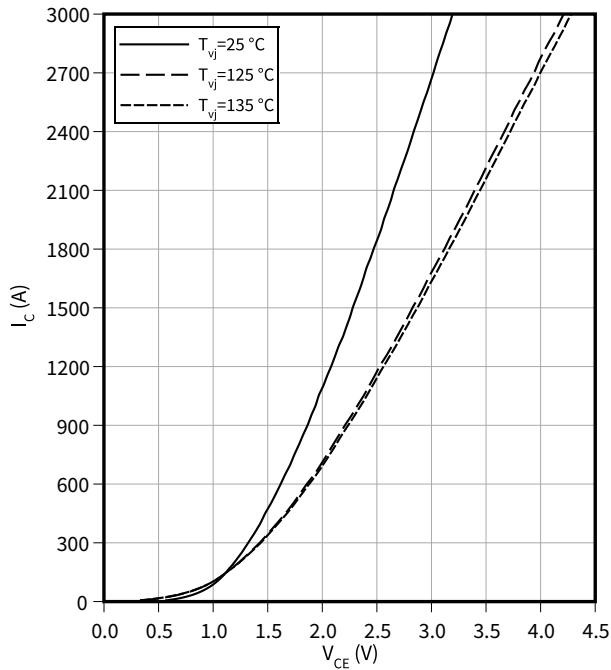
Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current	I_{RM}	$V_{CC} = 3600 \text{ V}$, $I_F = 1500 \text{ A}$, $V_{GE} = -15 \text{ V}$, $-di_F/dt = 3200 \text{ A}/\mu\text{s}$ ($T_{vj} = 135 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$	1580		A
			$T_{vj} = 125 \text{ }^\circ\text{C}$	1820		
			$T_{vj} = 135 \text{ }^\circ\text{C}$	1820		
Recovered charge	Q_r	$V_{CC} = 3600 \text{ V}$, $I_F = 1500 \text{ A}$, $V_{GE} = -15 \text{ V}$, $-di_F/dt = 3200 \text{ A}/\mu\text{s}$ ($T_{vj} = 135 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$	1980		μC
			$T_{vj} = 125 \text{ }^\circ\text{C}$	3620		
			$T_{vj} = 135 \text{ }^\circ\text{C}$	3800		
Reverse recovery energy	E_{rec}	$V_{CC} = 3600 \text{ V}$, $I_F = 1500 \text{ A}$, $V_{GE} = -15 \text{ V}$, $-di_F/dt = 3200 \text{ A}/\mu\text{s}$ ($T_{vj} = 135 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$	3560		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$	7740		
			$T_{vj} = 135 \text{ }^\circ\text{C}$	8190		
Thermal resistance, junction to case	R_{thJC}	per diode			12.8	K/kW
Thermal resistance, case to heat sink	R_{thCH}	per diode, $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$		6.8		K/kW
Temperature under switching conditions	$T_{vj\text{ op}}$		-50		135	$^\circ\text{C}$
Temperature under overload switching conditions	$T_{vj\text{ over}}$	Overload, cumulative max. 4000s			150	$^\circ\text{C}$

4 Characteristics diagrams

Output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$

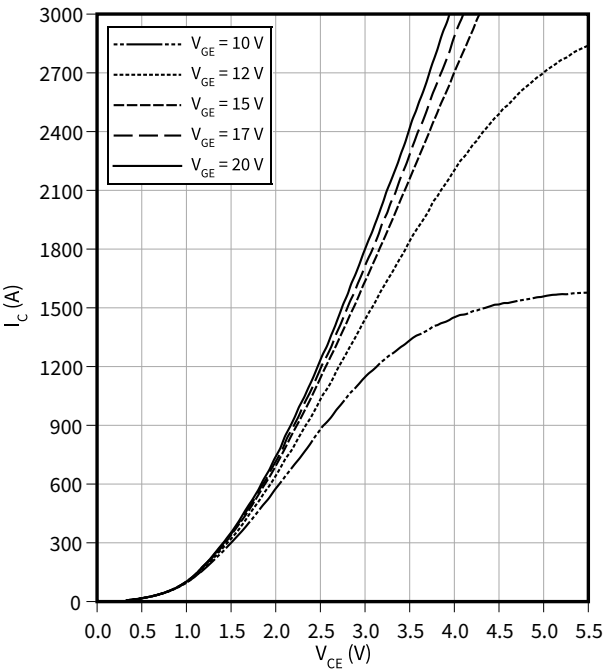
$V_{GE} = 15\text{ V}$



Output characteristic field (typical), IGBT, Inverter

$I_C = f(V_{CE})$

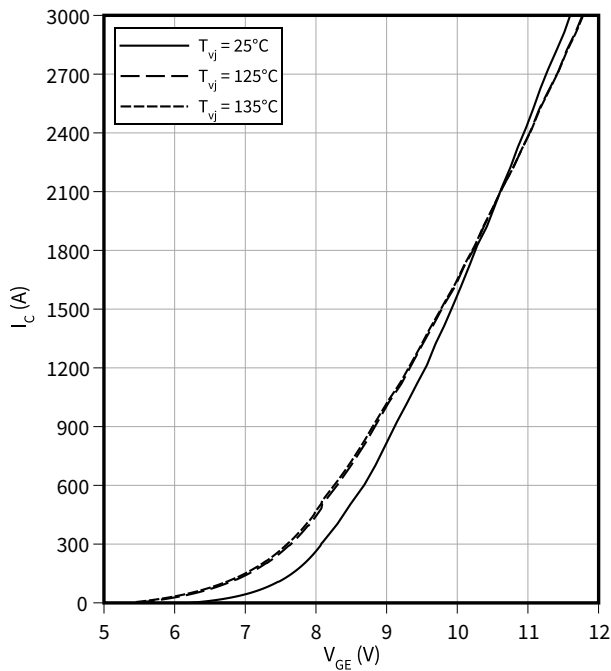
$T_{vj} = 135^\circ\text{C}$



Transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$

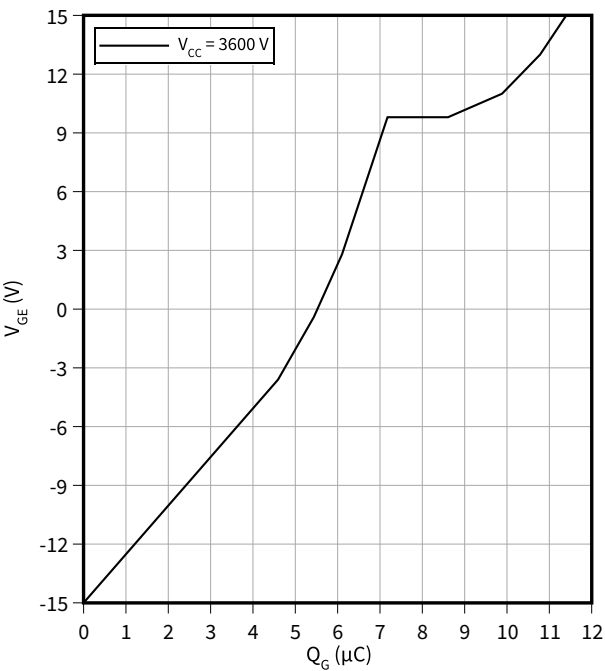
$V_{CE} = 20\text{ V}$



Gate charge characteristic (typical), IGBT, Inverter

$V_{GE} = f(Q_G)$

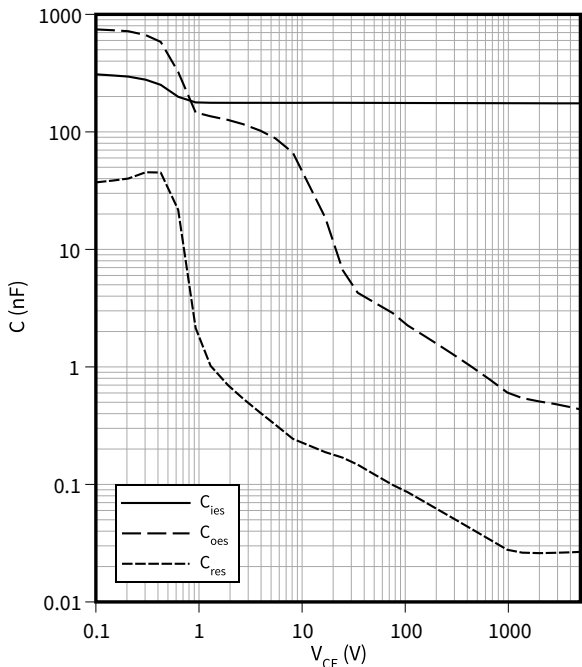
$I_C = 1500\text{ A}, T_{vj} = 25^\circ\text{C}$



4 Characteristics diagrams

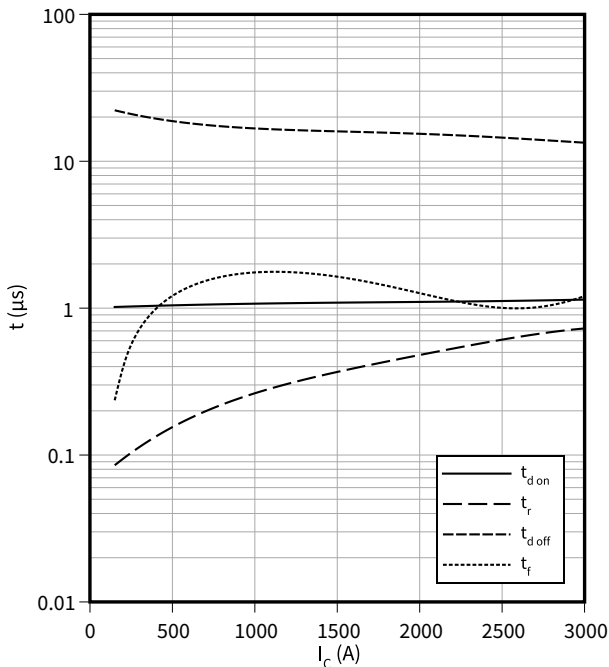
Capacity characteristic (typical), IGBT, Inverter

$C = f(V_{CE})$
 $f = 100\text{ kHz}$, $V_{GE} = 0\text{ V}$, $T_{vj} = 25\text{ }^{\circ}\text{C}$



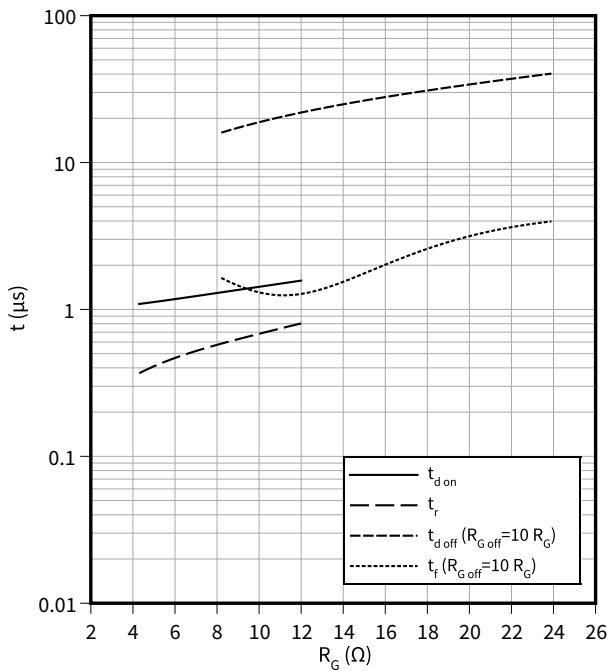
Switching times (typical), IGBT, Inverter

$t = f(I_C)$
 $R_{Goff} = 82\text{ }\Omega$, $R_{Gon} = 4.3\text{ }\Omega$, $V_{GE} = \pm 15\text{ V}$, $V_{CC} = 3600\text{ V}$,
 $T_{vj} = 135\text{ }^{\circ}\text{C}$



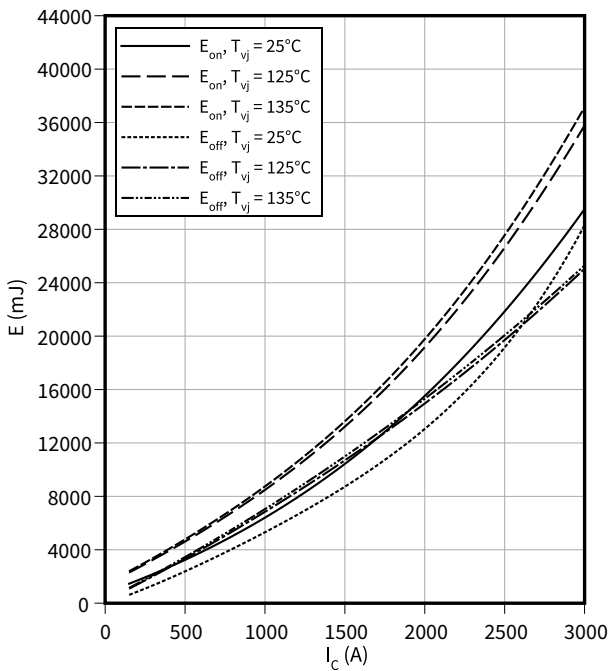
Switching times (typical), IGBT, Inverter

$t = f(R_G)$
 $V_{GE} = \pm 15\text{ V}$, $I_C = 1500\text{ A}$, $V_{CC} = 3600\text{ V}$, $T_{vj} = 135\text{ }^{\circ}\text{C}$



Switching losses (typical), IGBT, Inverter

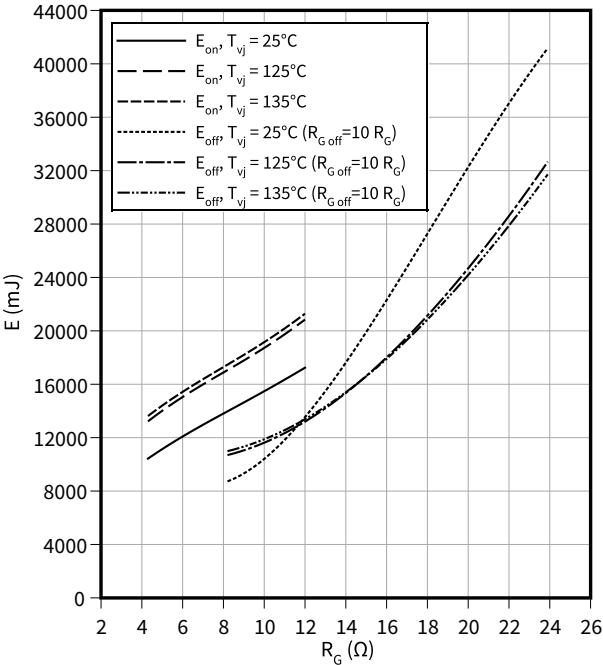
$E = f(I_C)$
 $R_{Goff} = 82\text{ }\Omega$, $R_{Gon} = 4.3\text{ }\Omega$, $V_{GE} = \pm 15\text{ V}$, $V_{CC} = 3600\text{ V}$



4 Characteristics diagrams

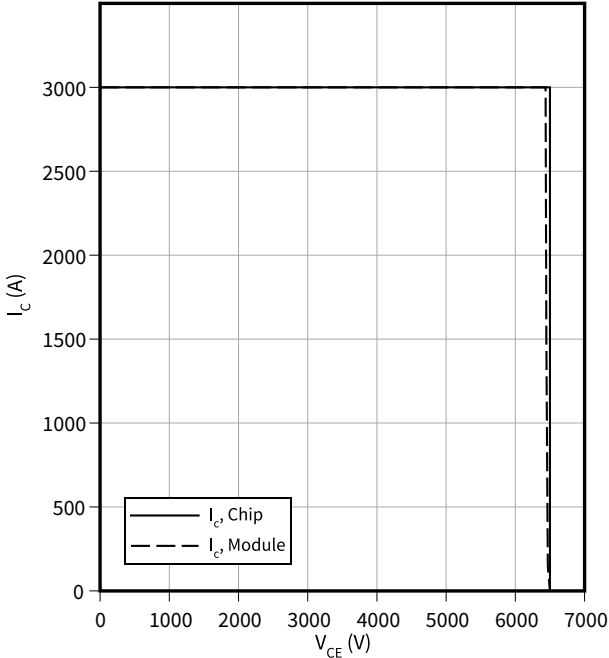
Switching losses (typical), IGBT, Inverter

$E = f(R_G)$
 $V_{GE} = \pm 15\text{ V}$, $I_C = 1500\text{ A}$, $V_{CC} = 3600\text{ V}$



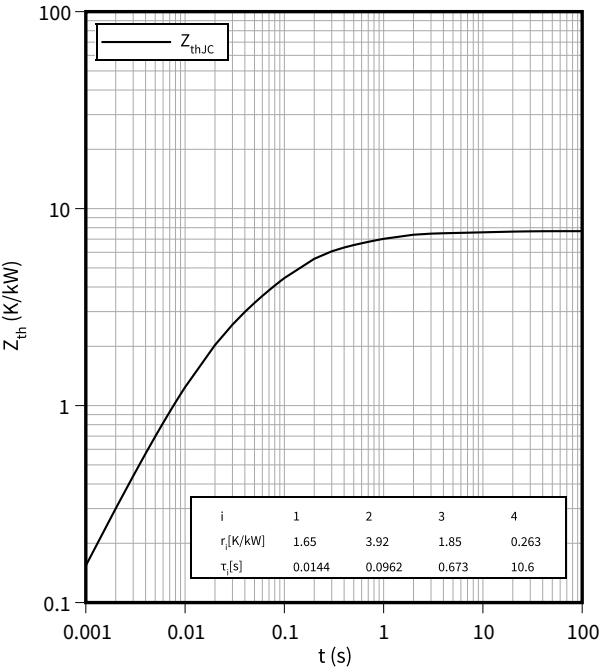
Reverse bias safe operating area (RBSOA), IGBT, Inverter

$I_C = f(V_{CE})$
 $R_{Goff} = 82\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $V_{CC} \leq 4500\text{ V}$, $T_{vj} = 135\text{ }^{\circ}\text{C}$



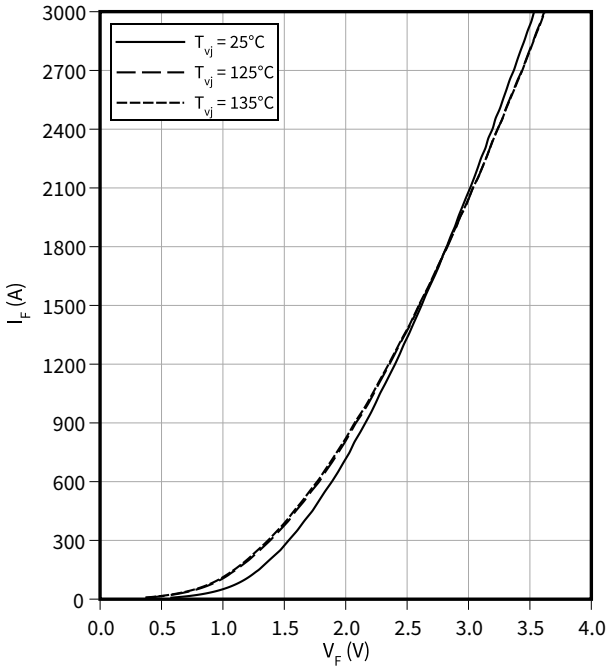
Transient thermal impedance, IGBT, Inverter

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, Inverter

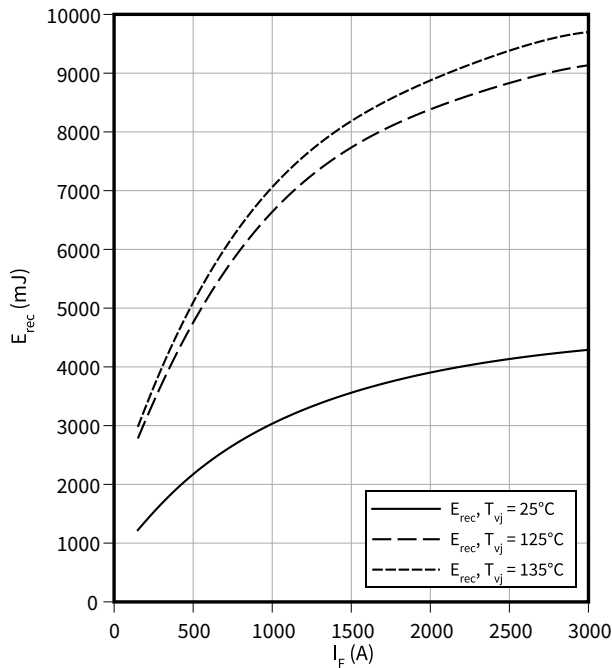
$I_F = f(V_F)$



4 Characteristics diagrams

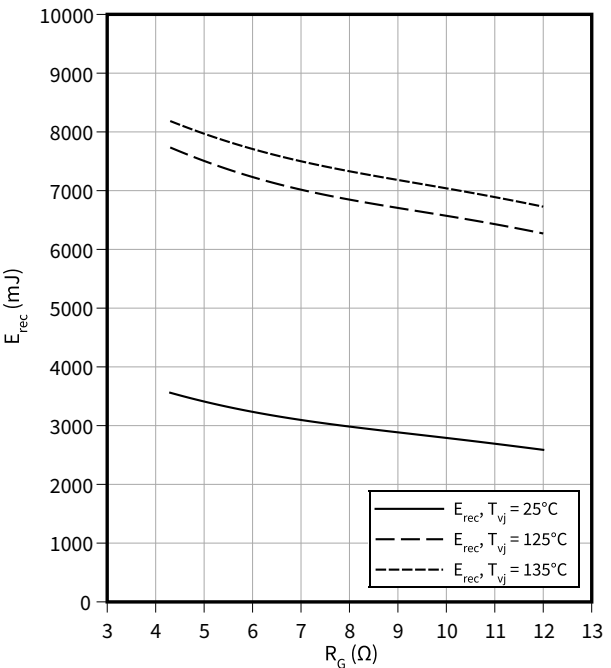
Switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$
 $R_{Gon} = R_{Gon}(IGBT)$, $V_{CC} = 3600\text{ V}$



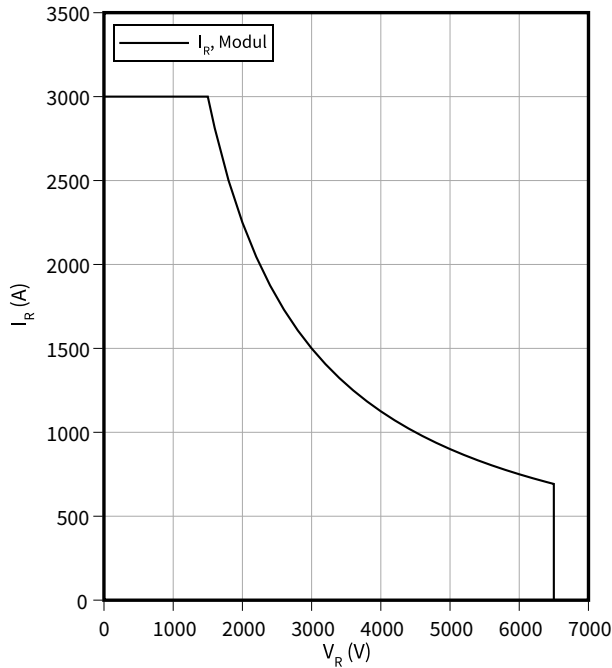
Switching losses (typical), Diode, Inverter

$E_{rec} = f(R_G)$
 $I_F = 1500\text{ A}$, $V_{CC} = 3600\text{ V}$



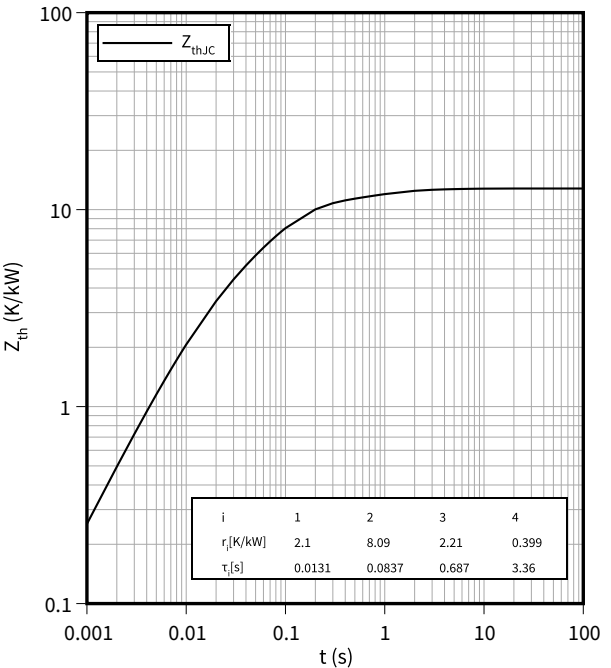
Safe operating area (SOA), Diode, Inverter

$I_R = f(V_R)$
 $T_{vj} = 135^\circ\text{C}$



Transient thermal impedance, Diode, Inverter

$Z_{th} = f(t)$



5 Circuit diagram

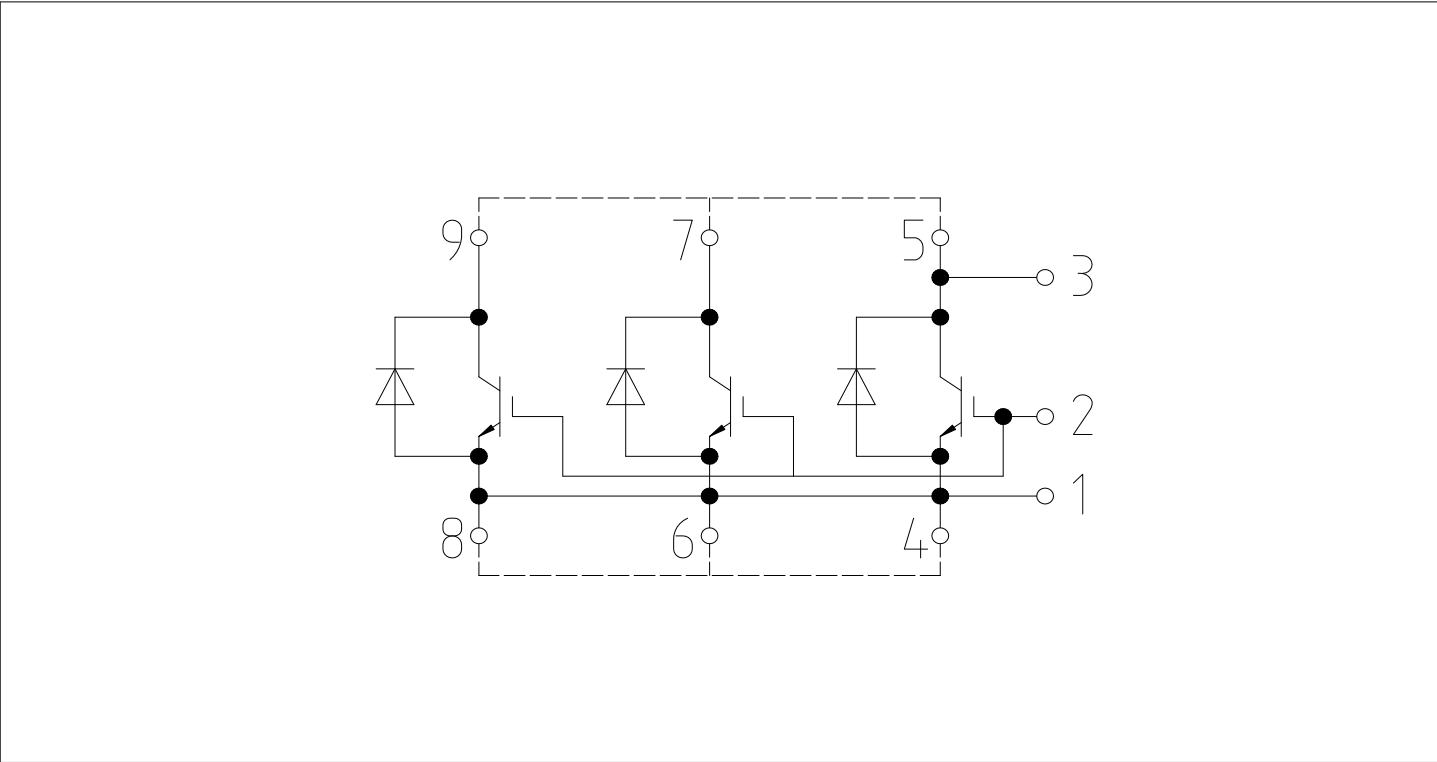


Figure 1

6 Package outlines

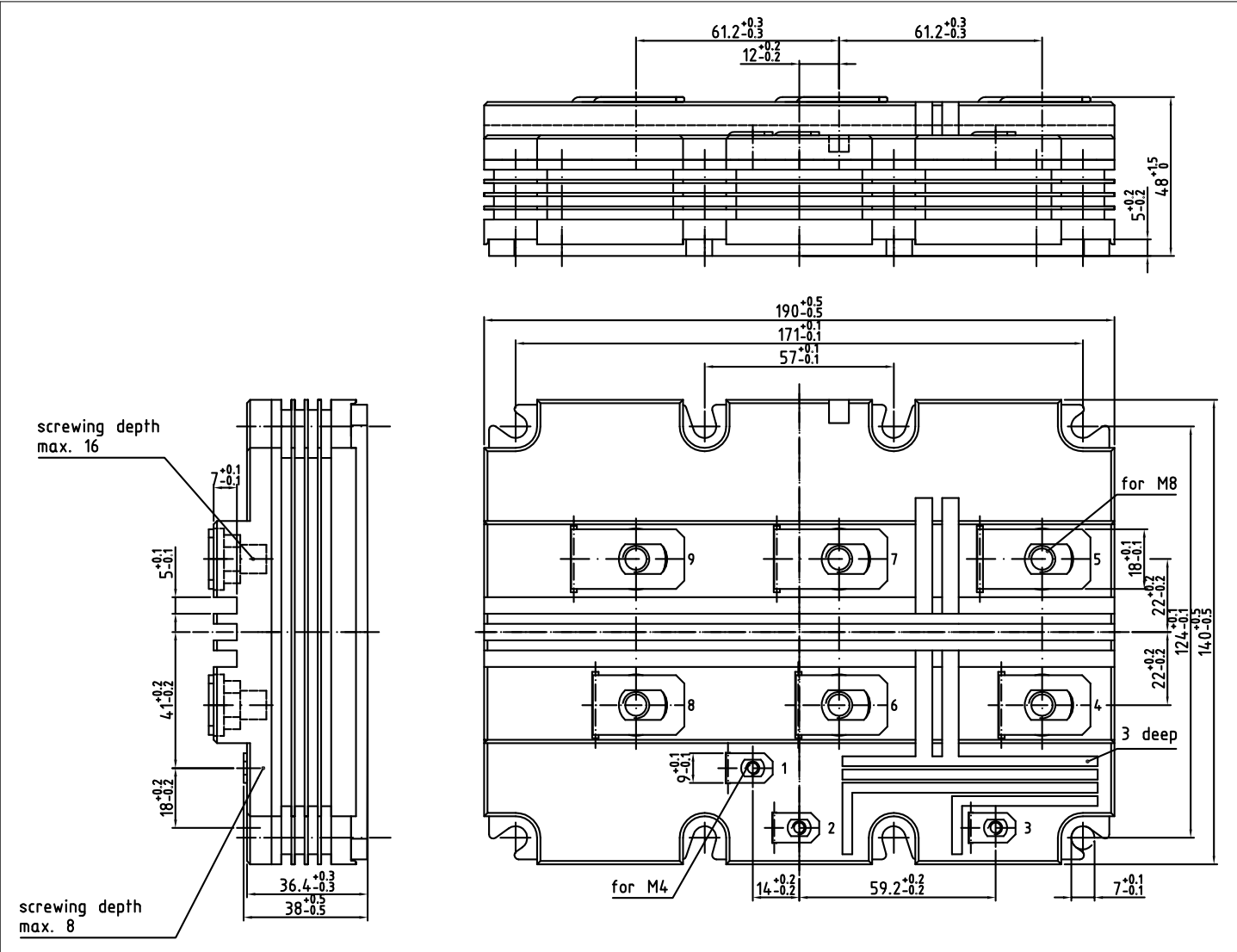


Figure 2

7 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	<i>Content</i>	<i>Digit</i>	<i>Example</i>
	Module serial number	1 – 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 – 21	15
	Date code (production week)	22 – 23	30
Example			
			
71549142846550549911530		71549142846550549911530	

Figure 3



Revision history

Revision history

Document revision	Date of release	Description of changes
0.10	2025-02-10	Target datasheet
0.20	2026-07-12	Preliminary datasheet
1.00	2026-08-06	Final datasheet

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